# 502004500 07/27/2012

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Yuichiro MIWA	06/18/2012
Masahiro KITAMURA	06/18/2012

#### **RECEIVING PARTY DATA**

Name:	Renesas Electronics Corporation
Street Address:	1753, Shimonumabe, Nakahara-ku
City:	Kawasaki-shi, Kanagawa
State/Country:	JAPAN

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13558763

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 098211-0177

NAME OF SUBMITTER: Effie Hale for George C. Beck

Total Attachments: 1

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PATENT REEL: 028656 FRAME: 0439 OF \$40.00 13558/63

# ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan,

located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said. Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

RECORDED: 07/27/2012

INVENTOR(S)

	(発明者フルネームサイン)	(署名日)
1)	Tuichiro Miwa Yulchiro MIWA	June 18. 2012
2) _	Masahivo Kitamuva Masahiro KITAMURA	June 18. 2012
3)		
4)		
5)		
6)		
7)		
8)		
9)	<u> </u>	
10)		

PATENT REEL: 028656 FRAME: 0440

**Date Signed**